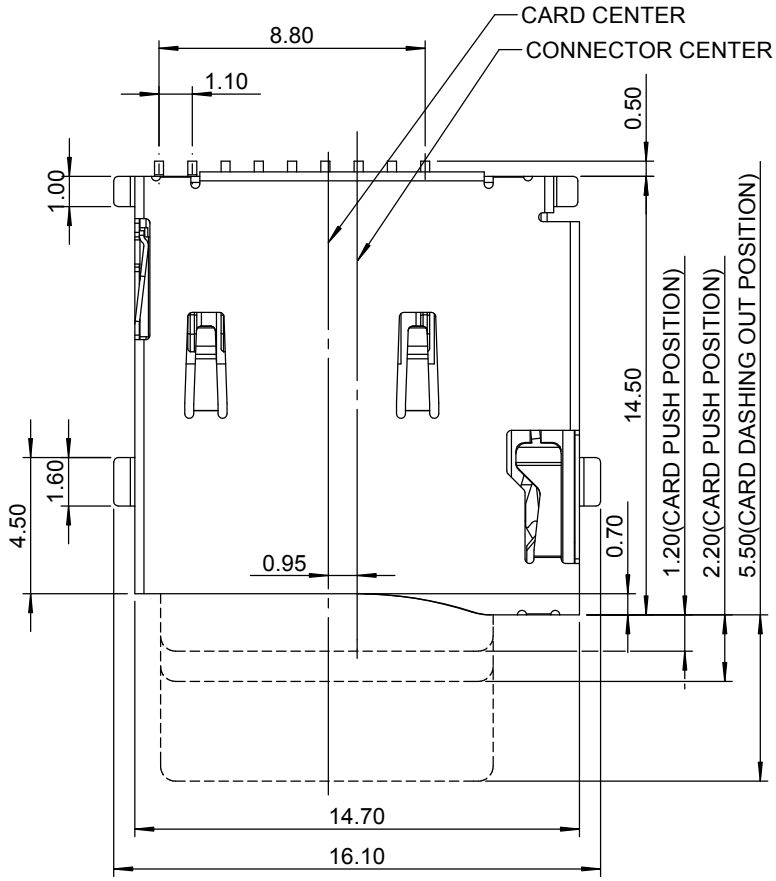
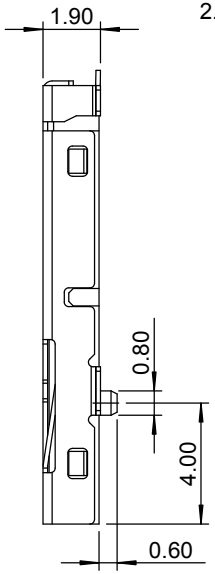
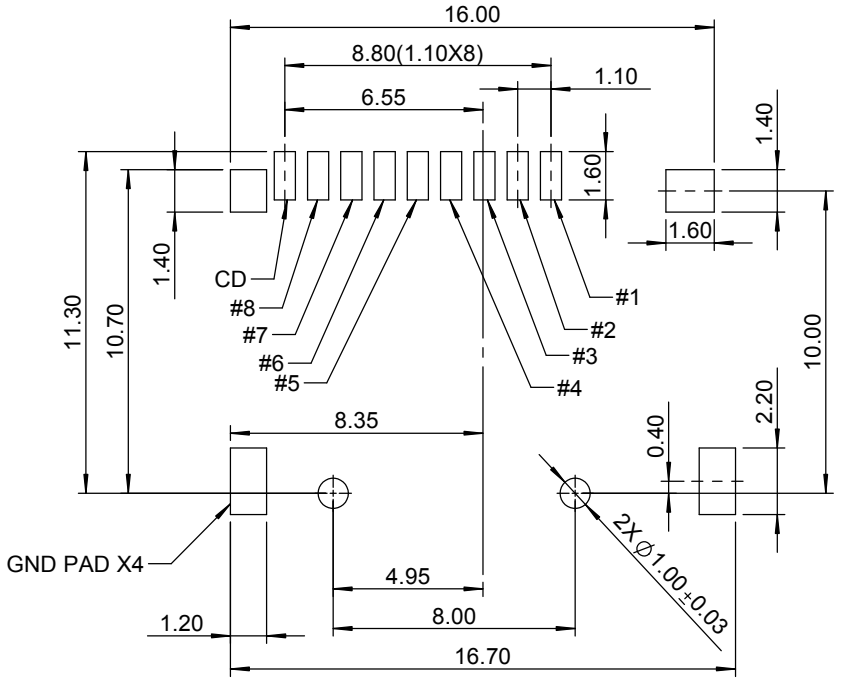
更改 REV	設 變 內 容 MODIFICATION
A	ECN01430

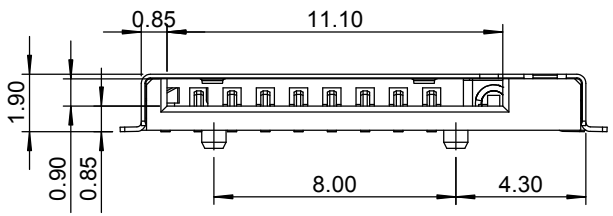
NOTES：
1.MATERIAL：
INSULATOR：HIGH TEMPERATURE THERMOPLASTIC
UL94V-0. COLOR：BLACK
CONTACT：PHOSPHOR BRONZE

2.PLATING：
CONTACT AREA：10μ" GOLD OVER 50μ" NICKEL
SOLDER TAIL：100μ" TIN OVER 50μ" NICKEL









Pin Assignment:	
#1	DTA2
#2	CD/DAT3
#3	CMD
#4	VDD
#5	CLK
#6	VSS
#7	DAT0
#8	DAT1²

WITHOUT CARD	CARD INSERTED
CD ○ ○ GROUND	CD ○——○ GROUND

GENERIAL TOLERANCE		KINGCONN 皇海科技股份有限公司		
X.± 0.50	X.°± 5°			
.X± 0.30	.X°± 2°			
.XX± 0.20	.XX°± 1°	名 稱(TITLE) microSD Push-Push Type Connector		
	.XXX°± 0.5°			
單 位(UNIT) mm	料 號(PART NO.) 7MSDP-B0-1012		圖 號(DWG NO.) 7MSDP-B0-1012	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 4 : 1	張 數 SHEET 1 / 1
			角 法 PROJ.	更 改 REV A